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Samtec to present new products and papers at DesignCon 2010

Samtec, Inc. will participate in the DesignCon 2010 conference and exhibition featuring three new products, a Technical Paper on high performance flex circuits and a joint TecForum on high frequency measurement past 40 GHz.

For high performance isolated transmission lines, IsoRate™ board-to-board connectors with Edge Rate™ contacts and cable assemblies with RG316 cable provide a low cost alternative to traditional RF components.

High density SEARAY™ open pin field arrays provide maximum grounding and routing flexibility with signal integrity optimized Edge Rate™ contacts. Seventeen standard board stack heights and new right angle designs and press fit tail options are now available as standards.

Samtec's EyeSpeed™ rugged high speed I/O connector and cable system provides a flexible, small form factor, cost-effective, and high cycle life system with two piece Edge Rate™ contacts suitable for performance specs to 4 Gbps and a variety of high speed protocols and standards.

Samtec has also been named a DesignVision finalist for its new BullsEye™ high performance, low cost test system.

Visit Samtec at Booth 315 or www.samtec.com/designcon for more information on Samtec's high speed capabilities.

